TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC240AP,TC74HC240AF,TC74HC241AP TC74HC241AF,TC74HC244AP,TC74HC244AF

Octal Bus Buffer

TC74HC240AP/AF Inverted, 3-State

Outputs

TC74HC241AP/AF Non-Inverted,

3-State Outputs

TC74HC244AP/AF Non-Inverted,

3-State Outputs

The TC74HC240A, 241A and 244A are high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate C2MOS technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

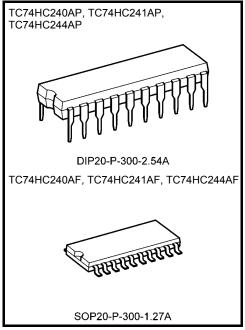
The 74HC240A is an inverting 3-state buffer having two active-low output enables. The TC74HC241A and TC74HC244A are non-inverting 3-state buffers that differ only in that the 241A has one active-high and one active-low output enable, and the 244A has two active-low output enables.

These devices are designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

- High speed: $t_{pd} = 10 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_{a} = 25 \text{°C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: |IOH| = IOL = 6 mA (min)
- Balanced propagation delays: $t_pLH \simeq t_pHL$
- Wide operating voltage range: V_{CC} (opr) = $2\sim6$ V
- Pin and function compatible with 74LS240/241/244

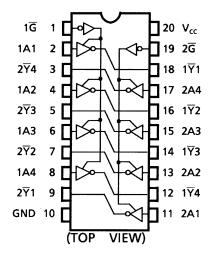


Weight

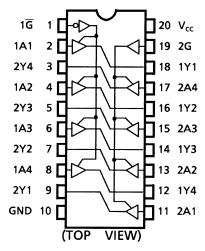
DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.)

Pin Assignment

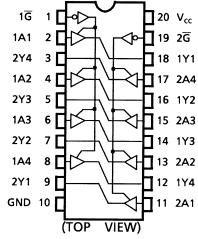
TC74HC240A



TC74HC241A

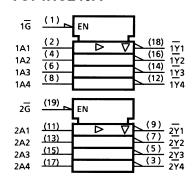


TC74HC244A

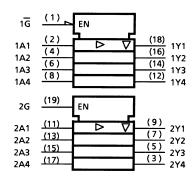


IEC Logic Symbol

TC74HC240A

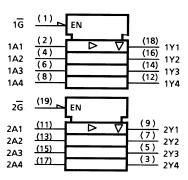


TC74HC241A



2

TC74HC244A



Truth Table

	Inputs	Outputs			
G	G∆	An	Yn	\overline{Y}_n $^{\Delta\Delta}$	
L	Н	L	L	Н	
L	Н	Н	Н	L	
Н	L	Х	Z	Z	

 Δ : For TC74HC241A only

 $\Delta\Delta$: For TC74HC240A only

X: Don't care

Z: High impedance



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	-0.5~7	V
DC input voltage	V _{IN}	-0.5~V _{CC} + 0.5	V
DC output voltage	V _{OUT}	-0.5~V _{CC} + 0.5	V
Input diode current	I _{IK}	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±35	mA
DC V _{CC} /ground current	Icc	±75	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	-65~150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65° C. From Ta = 65 to 85° C a derating factor of -10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2~6	V
Input voltage	V _{IN}	0~V _{CC}	V
Output voltage	V _{OUT}	0~V _{CC}	٧
Operating temperature	T _{opr}	-40~85	°C
		0~1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0~500 (V _{CC} = 4.5 V)	ns
		0~400 (V _{CC} = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.



Electrical Characteristics

DC Characteristics

Characteristics	Cumbal	Test Condition		Ta = 25°C			Ta = -40~85°C		Unit	
Characteristics	Symbol			V _{CC} (V)	Min	Тур.	Max	Min	Max	Unit
High-level input voltage		_		2.0	1.50	_	_	1.50	_	
	V_{IH}			4.5	3.15		_	3.15	_	V
				6.0	4.20	_	_	4.20	_	
				2.0	_	_	0.50	_	0.50	
Low-level input voltage	V_{IL}		_		_	_	1.35	_	1.35	V
				6.0	_	_	1.80	_	1.80	
				2.0	1.9	2.0	_	1.9	_	
	V _{ОН}	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	
High-level output voltage				6.0	5.9	6.0	_	5.9	_	V
			$I_{OH} = -6 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
	V _{OL}	V _{IN} = V _{IH} or V _{IL}		2.0	_	0.0	0.1	_	0.1	V
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage				6.0	_	0.0	0.1	_	0.1	
vollage			I _{OL} = 6 mA	4.5	_	0.17	0.26	_	0.33	
			I _{OL} = 7.8 mA	6.0	_	0.18	0.26	_	0.33	
3-state output off-state current	I _{OZ}	$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = V_{CC}$ or GND		6.0	_	_	±0.5	_	±5.0	μА
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0	_	_	±0.1	_	±1.0	μА
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		6.0	_	_	4.0	_	40.0	μА



AC Characteristics (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40~85°C		Unit	
Characteristics	Symbol		CL (pF)	V _{CC} (V)	Min	Тур.	Max	Min	Max	Offic
Output transition time	t _{TLH} t _{THL}	_	50	2.0 4.5 6.0		25 7 6	60 12 10	_ _ _	75 15 13	ns
Propagation delay time	t _{pLH} t _{pHL}	_	50	2.0 4.5 6.0	_ _ _	36 12 10	90 18 15	_ _ _	115 23 20	ns
			150	2.0 4.5 6.0		51 17 14	130 26 22	— — —	165 33 28	
Output enable time	^t pZL ^t pZH	$R_L = 1 \text{ k}\Omega$	50	2.0 4.5 6.0		48 16 14	125 25 21	_ _ _	155 31 26	ns
			150	2.0 4.5 6.0		63 21 18	165 33 28	_ _ _	205 41 35	
Output disable time	t _{pLZ} t _{pHZ}	$R_L = 1 \text{ k}\Omega$	50	2.0 4.5 6.0		32 15 14	125 25 21	_ _ _	155 31 26	ns
Input capacitance	C _{IN}	_			_	5	10	_	10	pF
Output capacitance	C _{OUT}	_				10	_	_	_	pF
Power dissipation capacitance	C _{PD} (Note)	TC74HC240A TC74HC241A/244A	\			31 33		_ _	_	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

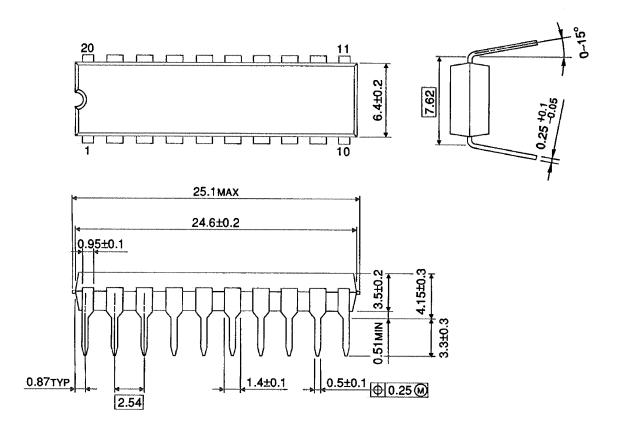
5

Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8$ (per bit)

Package Dimensions

DIP20-P-300-2.54A Unit: mm

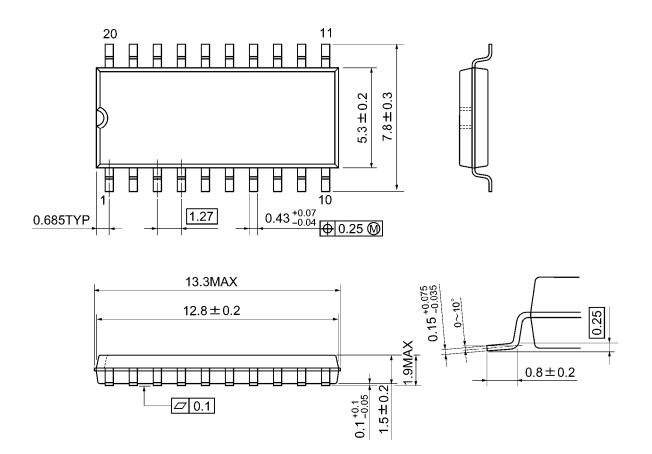


6

Weight: 1.30 g (typ.)

Package Dimensions

SOP20-P-300-1.27A Unit: mm



Weight: 0.22 g (typ.)



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8 2007-10-01